

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE PATENT APPLICATION OF: NAKADA et al.
SERIAL NO.: 10/551,695
ATTORNEY DOCKET NO.: 061063-0318214
FILING DATE: September 30, 2005
CONFIRMATION NO. 5511
ART UNIT: 1765
EXAMINER: AHMED, Shamim
FOR: HEAT TREATMENT JIG AND HEAT TREATMENT METHOD FOR SILICON WAFER

Response to Non-Final Office Action

Mail Stop Amendment

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Non-Final Office Action mailed March 24, 2008, the date for responding being June 24, 2008, please amend the above-identified application as follows:

Amendments to the claims begin on page 2 of this paper.

Remarks/Arguments begin on page 4.

It is not believed that extensions of time or fees for net addition of claims are required beyond those that may otherwise be provided for in documents accompanying this paper. However, if additional extensions of time are necessary to prevent abandonment of this application, then such extensions of time are hereby petitioned for under 37 C.F.R. § 1.136(a), and any fees required therefore (including fees for net addition of claims) are hereby authorized to be charged to our Deposit Account No. 033975 (Ref. No. 061063-0318214).